

# LQH5BPZ4R7NT0L Datasheet

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DiGi Electronics Part Number	LQH5BPZ4R7NT0L-DG
Manufacturer	<a href="#">Murata Electronics</a>
Manufacturer Product Number	LQH5BPZ4R7NT0L
Description	FIXED IND 4.7UH 2A 69.6MOHM SMD
Detailed Description	4.7 $\mu$ H Shielded Drum Core, Wirewound Inductor 2 A 69.6mOhm Max 2020 (5050 Metric)



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DiGi is a global authorized distributor of electronic components.

## Purchase and inquiry

**Manufacturer Product Number:**

LQH5BPZ4R7NT0L

**Series:**

LQH5

**Type:**

Drum Core, Wirewound

**Inductance:**4.7  $\mu$ H**Current Rating (Amps):**

2 A

**Shielding:**

Shielded

**Q @ Freq:**

-

**Ratings:**

AEC-Q200

**Inductance Frequency - Test:**

100 kHz

**Mounting Type:**

Surface Mount

**Supplier Device Package:**

2020

**Height - Seated (Max):**

0.087" (2.20mm)

**Manufacturer:**

Murata Electronics

**Product Status:**

Active

**Material - Core:**

Ferrite

**Tolerance:** $\pm$ 30%**Current - Saturation (Isat):**

3A

**DC Resistance (DCR):**

69.6mOhm Max

**Frequency - Self Resonant:**

40MHz

**Operating Temperature:**

-40°C ~ 85°C

**Features:**

-

**Package / Case:**

2020 (5050 Metric)

**Size / Dimension:**

0.197" L x 0.197" W (5.00mm x 5.00mm)

**Base Product Number:**

LQH5BPZ

## Environmental & Export classification

**RoHS Status:**

ROHS3 Compliant

**REACH Status:**

REACH Unaffected

**HTSUS:**

8504.50.8000

**Moisture Sensitivity Level (MSL):**

1 (Unlimited)

**ECCN:**

EAR99

**CHIP COIL (CHIP INDUCTOR) for Automotive infotainment/comfort equipment  
LQH5BPZ□□□□T0□ Murata Standard REFERENCE Specification AEC-Q200**

**1. Scope**

This reference specification applies to chip coil (chip inductor) LQH5BPZ\_T0series based on AEC-Q200.

**1.1 Specific applications:**

- Automotive infotainment/comfort equipment: Products that can be used for automotive equipment such as car navigation systems and car audio systems that do not directly relate to human life and whose structure, equipment, and performance are not specifically required by law to meet technical standards for safety assurance or environmental protection.
- Industrial equipment: Products that can be used in industrial equipment such as base stations, manufacturing equipment, industrial robotics equipment, and measurement equipment, and whose functions do not directly relate to the protection of human life and property.
- Medical equipment (GHTF Class C) \*Except for implant/surgery/auto injector: Products that can be used for medical equipment of Class C of the international classification class GHTF and whose malfunction is considered to pose a relatively high risk to the human body.
- Medical equipment (GHTF Class A and B): Products that can be used for medical equipment regulated by Class A and Class B of the international classification class GHTF and whose functions do not directly relate to the protection of human life and property.
- Consumer equipment: Products that can be used in consumer equipment such as home appliances, audio/visual equipment, communication equipment, information equipment, office equipment, and household robotics, and whose functions are not directly related to the protection of human life and property.

**1.2 Unsuitable application:**

Applications listed in "Limitation of applications" in this reference specification.

**2.Part Numbering**

(ex)	LQ	H	5B	P	Z	R47	N	T0	L
	Product ID	Structure	Dimension (L×W)	Applications and Characteristics	Category	Inductance	Tolerance	Dimension (T)	Packaging L:Taping (φ180mm/reel) K:Taping (φ330mm/reel)

**3.Rating**

Operating Temperature Range.  
 (Ambient temperature; Self-temperature rise is not included)      -40 to +105°C  
 (Product temperature; Self- temperature rise is included)      -40 to +125°C  
 Storage Temperature Range.      -40 to +125°C

Customer Part Number	MURATA Part Number	Inductance		DC Resistance ( )	Self Resonant Frequency (MHz min)	3 Rated Current(A)					ESD 5A : 8kV
		(μH)	Tolerance (%)			1 Based on Inductance change		2(Based on Temperature rise)			
						Max.	Typ.	Ambient temperature 85°C		Ambient temperature 105°C	
							Max.	Typ.	Max.		
	LQH5BPZR47NT0L	0.47		0.012±20%	220	7.7	10	4.0	5.2	2.05	5A
	LQH5BPZR47NT0K										
	LQH5BPZ1R0NT0L	1.0		0.019±20%	90	5.8	7.9	3.1	4.4	1.68	
	LQH5BPZ1R0NT0K										
	LQH5BPZ1R2NT0L	1.2		0.019±20%	90	5.4	7.0	3.1	4.4	1.68	
	LQH5BPZ1R2NT0K										
	LQH5BPZ1R5NT0L	1.5		0.024±20%	70	5.0	6.6	3.0	4.2	1.63	
	LQH5BPZ1R5NT0K										
	LQH5BPZ2R2NT0L	2.2		0.030±20%	55	4.0	5.5	2.6	3.7	1.37	
	LQH5BPZ2R2NT0K										
	LQH5BPZ2R7NT0L	2.7		0.035±20%	50	3.8	4.9	2.5	3.3	1.23	
	LQH5BPZ2R7NT0K										

Customer Part Number	MURATA Part Number	Inductance		DC Resistance ( )	Self Resonant Frequency (MHz min)	3 Rated Current(A)					ESD 5A : 8kV
		(μH)	Tolerance (%)			1 Based on Inductance change		2(Based on Temperature rise)			
						Max.	Typ.	Ambient temperature 85°C		Ambient temperature 105°C	
						Max.	Typ.	Max.	Typ.	Max.	
	LQH5BPZ3R3NT0L	3.3	N:±30	0.044±20%	40	3.5	4.6	2.3	3.1	1.21	5A
	LQH5BPZ3R3NT0K										
	LQH5BPZ4R7NT0L	4.7		0.058±20%	40	3.0	3.9	2.0	2.8	1.09	
	LQH5BPZ4R7NT0K										
	LQH5BPZ6R8NT0L	6.8		0.083±20%	30	2.5	3.1	1.65	2.4	0.96	
	LQH5BPZ6R8NT0K										
	LQH5BPZ100MT0L	10	M:±20	0.106±20%	25	2.0	2.6	1.60	2.2	0.87	
	LQH5BPZ100MT0K										
	LQH5BPZ150MT0L	15		0.187±20%	18	1.6	2.2	1.20	1.6	0.62	
	LQH5BPZ150MT0K										
	LQH5BPZ220MT0L	22		0.259±20%	15	1.4	1.9	1.05	1.4	0.55	
	LQH5BPZ220MT0K										

- 1: When applied Rated current to the Products, Inductance will be within ±30% of nominal Inductance value.
- 2: When applied Rated current to the Products ,temperature rise caused by self-generated heat shall be limited to 40°C max.
- 3: Keep the temperature (ambient temperature plus self-generation of heat) under 125°C.

#### 4. Testing Conditions

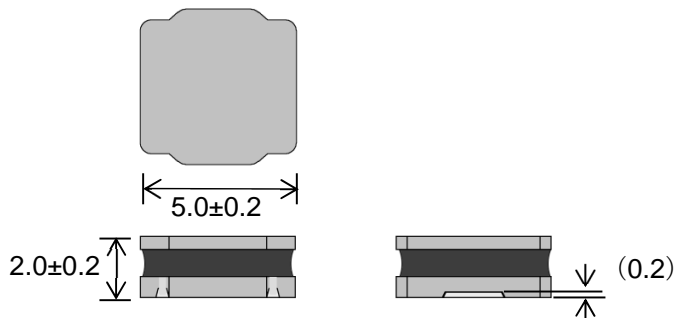
Unless otherwise specified

Temperature : Ordinary Temperature (15 to 35°C)  
Humidity : Ordinary Humidity (25 to 85 % (RH))

In case of doubt

Temperature : 20 ± 2°C  
Humidity : 60 to 70 % (RH)  
Atmospheric Pressure : 86 to 106 kPa

#### 5.Appearance and Dimensions



※ No Marking.

Unit Mass (Typical value)  
0.22 g

(in mm)

**6. Electrical Performance**

No.	Item	Specification	Test Method
6.1	Inductance	Inductance shall meet item 3.	Measuring Equipment : KEYSIGHT 4284A or equivalent Measuring Frequency: 100kHz
6.2	DC Resistance	DC Resistance shall meet item 3.	Measuring Equipment: Digital multi meter
6.3	Self Resonant Frequency(S.R.F)	S.R.F shall meet item 3.	Measuring Equipment: KEYSIGHT E4991A or equivalent

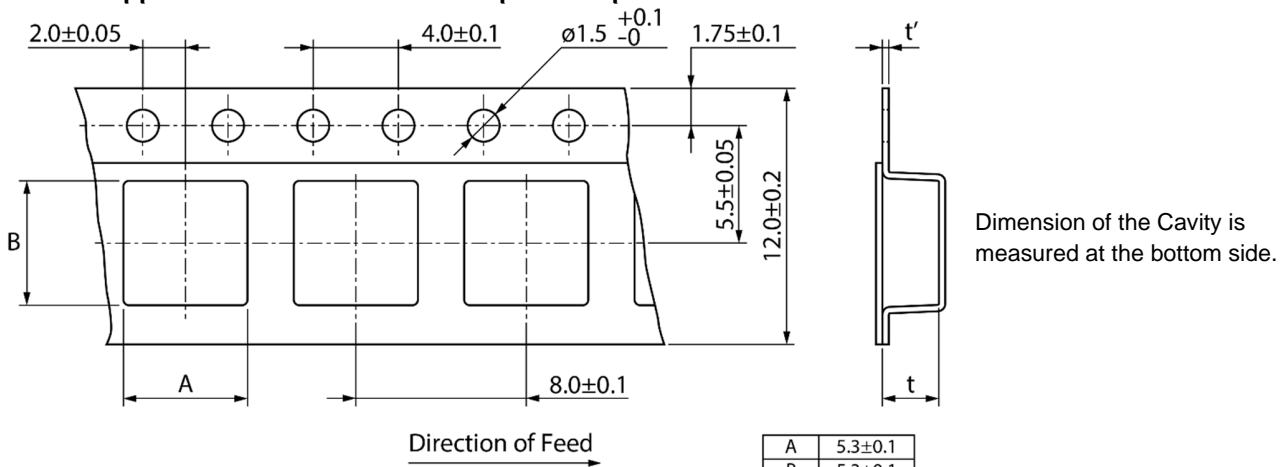
**7. AEC-Q200 Requirement****7.1 Performance (based on Table 5 for Magnetics(Inductors / Transformer)****AEC-Q200 Rev.D issued June. 1 2010**

AEC-Q200			Murata Specification / Deviation						
No	Stress	Test Method							
3	High Temperature Exposure	1000hours at 105 °C Set for 24hours at room temperature, then measured.	Meet Table A after testing. Table A <table border="1"> <tr> <td>Appearance</td> <td>No damage</td> </tr> <tr> <td>Inductance change (at 100kHz)</td> <td>Within ±10%</td> </tr> <tr> <td>DC Resistance change</td> <td>Within ±10%</td> </tr> </table>	Appearance	No damage	Inductance change (at 100kHz)	Within ±10%	DC Resistance change	Within ±10%
Appearance	No damage								
Inductance change (at 100kHz)	Within ±10%								
DC Resistance change	Within ±10%								
4	Temperature Cycling	1000cycles -40 °C to + 125 °C Set for 24hours at room temperature, then measured.	Meet Table A after testing.						
7	Biased Humidity	1000hours at 85 °C, 85%RH unpowered.	Meet Table A after testing.						
8	Operational Life	Apply 85 °C 1000 hours Set for 24hours at room temperature, then measured	Meet Table A after testing.						
9	External Visual	Visual inspection	No abnormalities						
10	Physical Dimension	Meet ITEM 5 (Style and Dimensions)	No defects						
12	Resistance to Solvents	Per MIL-STD-202 Method 215	Not Applicable						
13	Mechanical Shock	Per MIL-STD-202 Method 213 Condition C: 100g's/6ms/Half sine	Meet Table A after testing.						
14	Vibration	5g's for 20 minutes, 12cycles eah of 3 orientations Test from 10-2000Hz. 12cycles each of 3 orientations	Meet Table A after testing.						
15	Resistance to Soldering Heat	No-heating Solder temperature 260C+/-5 °C Immersion time 10s	Meet Table A after testing.						

AEC-Q200			Murata Specification / Deviation
No	Stress	Test Method	
17	ESD	Per AEC-Q200-002	ESD Rank: Refer to Item 3. Rating. No defects
18	Solderbility	Per J-STD-002	Method b : Not Applicable 90% of the terminations is to be soldered. (Except exposed wire)
19	Electrical Characterization	Measured : Inductance	No defects
20	Flammability	Per UL-94	Not Applicable
21	Board Flex	Epoxy-PCB(1.6mm) Deflection 2mm(min) 60s minimum holding time	Meet Table A after testing. Murata deviation request: 5s
22	Terminal Strength	Per AEC-Q200-006 A force of 17.7N for 60s	No defects

**8. Specification of Packaging**

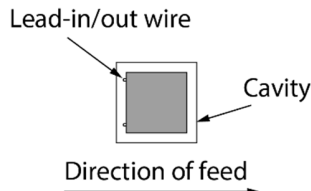
**8.1 Appearance and Dimensions of plastic tape**



A	5.3±0.1
B	5.3±0.1
t	2.4±0.1
t'	(0.3)

(in mm)

■ Top view



## 8.2 Specification of Taping

- (1) Packing quantity (standard quantity)
  - φ180 mm reel : 500 pcs. / reel
  - φ330 mm reel : 3000 pcs. / reel
- (2) Packing Method
 

Products shall be packed in the each embossed cavity of plastic tape and sealed by cover tape.
- (3) Sprocket hole
 

The sprocket holes are to the right as the tape is pulled toward the user.
- (4) Spliced point
 

Plastic tape and Cover tape has no spliced point.
- (5) Missing components number
 

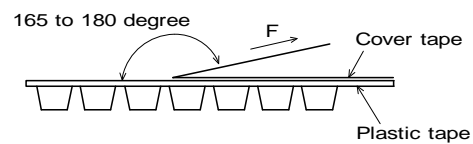
Missing components number within 0.025 % of the number per reel or 1 pc., whichever is greater, and are not continuous. The specified quantity per reel is kept.

## 8.3 Pull Strength

Embossed carrier tape	10N min.
Cover tape	5N min.

## 8.4 Peeling off force of cover tape

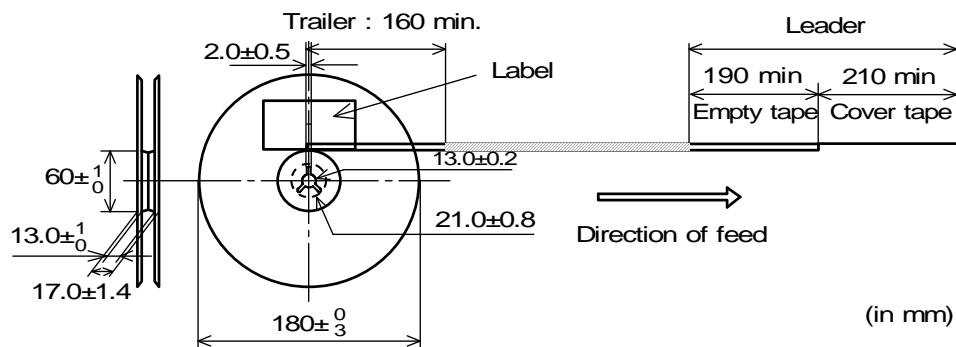
Speed of Peeling off	300mm/min
Peeling off force	0.2 to 0.7N (minimum value is typical)



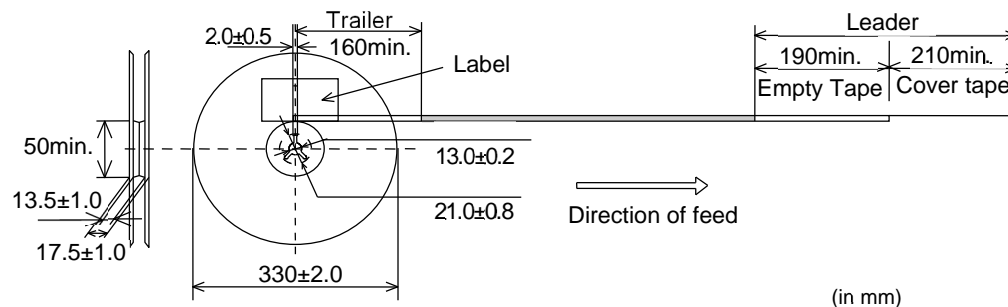
## 8.5 Dimensions of Leader-tape, Trailer and Reel

There shall be leader-tape (cover tape) and trailer-tape (empty tape) as follows.

« Packaging Code : L (φ180mm reel) »



« Packaging Code : K (φ330mm reel) »



**8.6 Marking for reel**

Customer part number, MURATA part number, Inspection number( 1), RoHS marking( 2), Quantity etc ...

1) <Expression of Inspection No.>  $\frac{\text{OOOO}}{\text{(1) (2) (3)}}$ 

(1) Factory Code

(2) Date

First digit : Year / Last digit of year

Second digit : Month / Jan. to Sep. 1 to 9, Oct. to Dec. O, N, D

Third, Fourth digit : Day

(3) Serial No.

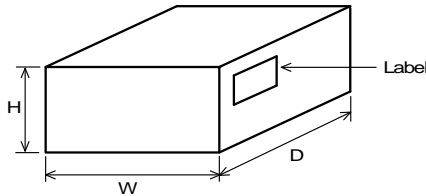
2) « Expression of RoHS marking » ROHS -  $\frac{Y(\Delta)}{(1) (2)}$ 

(1) RoHS regulation conformity

(2) MURATA classification number

**8.7 Marking for Outside package (corrugated paper box)**

Customer name, Purchasing order number, Customer part number, MURATA part number, RoHS marking ( 2), Quantity, etc ...

**8.8 Specification of Outer Case**

Reel	Outer Case imensions (mm)			Standard Reel Quantity in Outer Case (Reel)
	W	D	H	
φ180mm	186	186	93	5
φ330mm	340	340	95	5

Above Outer Case size is typical. It depends on a quantity of an order.

**9. ⚠ Caution****9.1 Limitation of applications**

The products listed in the reference specification (hereinafter the product(s) is called as the "Product(s)") are designed and manufactured for applications specified in the reference specification (hereinafter called as the "Specific Application").

We shall not warrant anything in connection with the Products including fitness, performance, adequateness, safety, or quality, in the case of applications listed in from (1) to (11) written at the end of this precautions, which may generally require high performance, function, quality, management of production or safety. Therefore, the Product shall be applied in compliance with the specific application.

WE DISCLAIM ANY LOSS AND DAMAGES ARISING FROM OR IN CONNECTION WITH THE PRODUCTS INCLUDING BUT NOT LIMITED TO THE CASE SUCH LOSS AND DAMAGES CAUSED BY THE UNEXPECTED ACCIDENT, IN EVENT THAT (i) THE PRODUCT IS APPLIED FOR THE PURPOSE WHICH IS NOT SPECIFIED AS THE SPECIFIC APPLICATION FOR THE PRODUCT, AND/OR (ii) THE PRODUCT IS APPLIED FOR ANY FOLLOWING APPLICATION PURPOSES FROM (1) TO (11) (EXCEPT THAT SUCH APPLICATION PURPOSE IS UNAMBIGUOUSLY SPECIFIED AS SPECIFIC APPLICATION FOR THE PRODUCT IN OUR CATALOG SPECIFICATION FORMS, DATASHEETS, OR OTHER DOCUMENTS OFFICIALLY ISSUED BY US\*).

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment
- (4) Power plant control equipment
- (5) Medical equipment
- (6) Transportation equipment
- (7) Traffic control equipment
- (8) Disaster prevention/security equipment
- (9) Industrial data-processing equipment
- (10) Combustion/explosion control equipment
- (11) Equipment with complexity and/or required reliability equivalent to the applications listed in the above.

For exploring information of the Products which will be compatible with the particular purpose other than those specified in the reference specification, please contact our sales offices, distribution agents, or trading companies with which you make a deal, or via our web contact form.

Contact form: <https://www.murata.com/contactform>

\* We may design and manufacture particular Products for applications listed in (1) to (11). Provided that, in such case we shall unambiguously specify such Specific Application in the reference specification without any exception. Therefore, any other documents and/or performances, whether exist or non-exist, shall not be deemed as the evidence to imply that we accept the applications listed in (1) to (11).



**9.2 Caution(Rating)**

Do not exceed maximum rated current of the product. Thermal stress may be transmitted to the product and short/open circuit of the product or falling off the product may be occurred.

**9.3 Fail-safe**

Be sure to provide an appropriate fail-safe function on your product to prevent a second damage that may be caused by the abnormal function or the failure of our product.

**9.4 Corrosive gas**

Please refrain from use since contact with environments with corrosive gases (sulfur gas [hydrogen sulfide, sulfur dioxide, etc.], chlorine, ammonia, etc.) or oils (cutting oil, silicone oil, etc.) that have come into contact with the previously stated corrosive gas environment will result in deterioration of product quality or an open from deterioration due to corrosion of product electrode, etc. We will not bear any responsibility for use under these environments.

**10. Notice**

This product is designed for solder mounting.

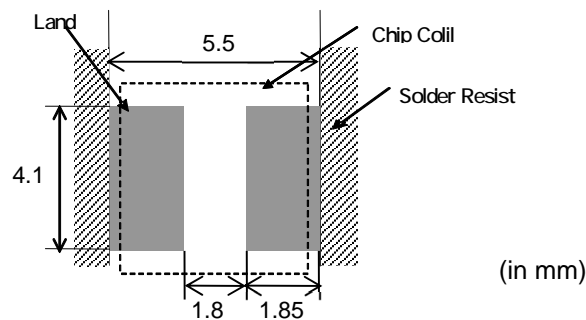
Please consult us in advance for applying other mounting method such as conductive adhesive.

**10.1 Land pattern designing (Reflow Soldering)**

Recommended land patterns for reflow soldering are as follows:

These have been designed for Electric characteristics and solderability.

Please follow the recommended patterns. Otherwise, their performance which includes electrical performance or solderability may be affected, or result to "position shift" in soldering process.

**10.2 Flux, Solder**

Flux	<ul style="list-style-type: none"> <li>• Use rosin-based flux.</li> <li>• Don't use highly acidic flux with halide content exceeding 0.2(wt)% (chlorine conversion value).</li> <li>• Don't use water-soluble flux.</li> </ul>
Solder	<ul style="list-style-type: none"> <li>• Use Sn-3.0Ag-0.5Cu solder.</li> <li>• Standard thickness of solder paste : 100μm to 150μm</li> </ul>

### 10.3 Soldering conditions (Reflow)

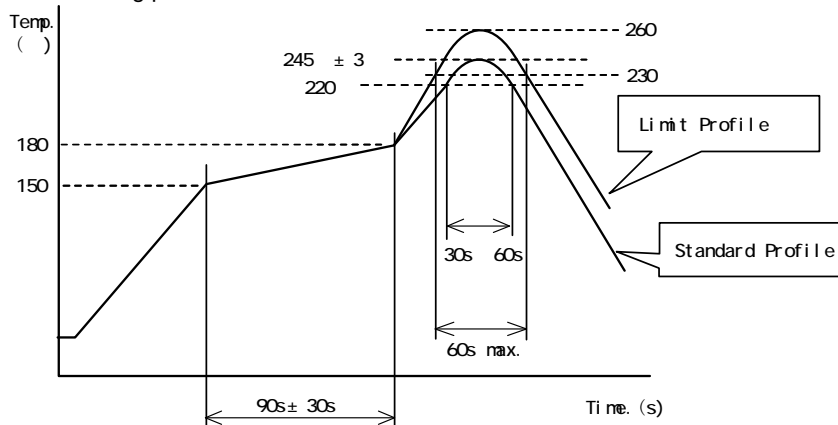
Pre-heating should be in such a way that the temperature difference between solder and product surface is limited to 100°C max. Cooling into solvent after soldering also should be in such a way that the temperature difference is limited to 100°C max.

Insufficient pre-heating may cause cracks on the product, resulting in the deterioration of product quality.

Standard soldering profile and the limit soldering profile is as follows.

The excessive limit soldering conditions may cause leaching of the electrode and / or resulting in the deterioration of product quality.

Reflow soldering profile



	Standard Profile	Limit Profile
Pre-heating	150 180°C	90s±30s
Heating	above 220°C 30s 60s	above 230°C 60s max.
Peak temperature	245±3°C	260°C, 10s
Cycle of reflow	2 times	2 times

### 10.4 Reworking with soldering iron.

The following conditions must be strictly followed when using a soldering iron.

Pre-heating	150°C, 1 min
Tip temperature	380°C max.
Soldering iron output	80W max.
Tip diameter	3mm max.
Soldering time	3(+1,-0)s
Times	2 times

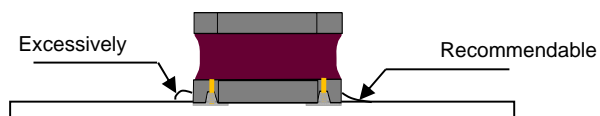
Note : Do not directly touch the products with the tip of the soldering iron in order to prevent the crack on the products due to the thermal shock.

### 10.5 Solder Volume

Solder shall be used not to be exceeded the upper limits as shown below.

Accordingly increasing the solder volume, the mechanical stress to Chip is also increased.

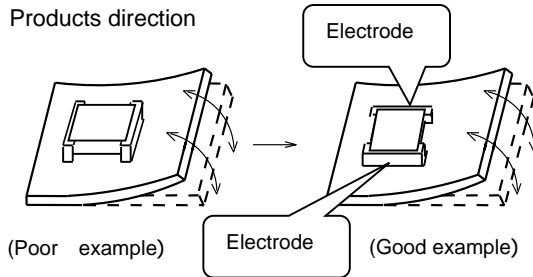
Exceeding solder volume may cause the failure of mechanical or electrical performance.



### 10.6 Product's location

The following shall be considered when designing and laying out P.C.B.'s.

- (1) P.C.B. shall be designed so that products are not subject to the mechanical stress due to warping the board.



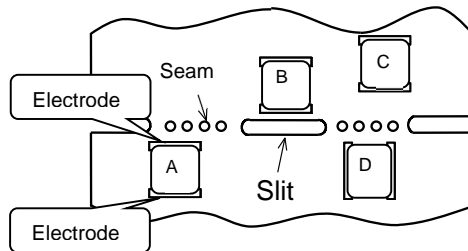
The electrode part of the products should be located like the picture to the mechanical stress.

- (2) Components location on P.C.B. separation.

It is effective to implement the following measures, to reduce stress in separating the board.

It is best to implement all of the following three measures; however, implement as many measures as possible to reduce stress.

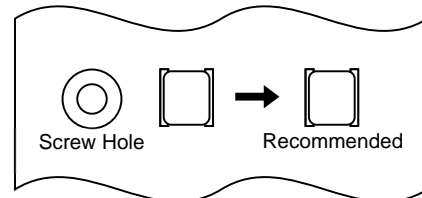
Contents of Measures	Stress Level
(1) Turn the mounting direction of the component parallel to the board separation surface.	A > D 1
(2) Add slits in the board separation part.	A > B
(3) Keep the mounting position of the component away from the board separation surface.	A > C



1 A > D is valid when stress is added vertically to the perforation as with Hand Separation.  
If a Cutting Disc is used, stress will be diagonal to the PCB, therefore A > D is invalid.

- (3) Mounting Components Near Screw Holes

When a component is mounted near a screw hole, it may be affected by the board deflection that occurs during the tightening of the screw. Mount the component in a position as far away from the screw holes as possible.



### 10.7 Cleaning Conditions

Products shall be cleaned on the following conditions.

- (1) Cleaning temperature shall be limited to 60°C max.(40°C max for IPA.)
- (2) Ultrasonic cleaning shall comply with the following conditions with avoiding the resonance phenomenon at the mounted products and P.C.B.  
Power : 20 W / l max.      Frequency : 28kHz to 40kHz      Time : 5 minutes max.
- (3) Cleaner
  1. Alternative cleaner  
Isopropyl alcohol (IPA)
  2. Aqueous agent  
PINE ALPHA ST-100S
- (4) There shall be no residual flux and residual cleaner after cleaning.  
In the case of using aqueous agent, products shall be dried completely after rinse with de-ionized water in order to remove the cleaner.
- (5) Other cleaning  
Please contact us.

**10.8 Resin coating**

The inductance value may change due to high cure-stress of resin to be used for coating/molding products. An open circuit issue may occur by mechanical stress caused by the resin, amount/cured shape of resin, or operating condition etc. Some resin contains some impurities or chloride possible to generate chlorine by hydrolysis under some operating condition may cause corrosion of wire of coil, leading to open circuit. So, please pay your careful attention when you select resin in case of coating/molding the products with the resin. Prior to use the coating resin, please make sure no reliability issue is observed by evaluating products mounted on your board.

**10.9 Caution for use**

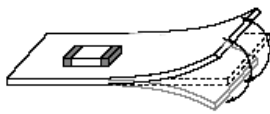
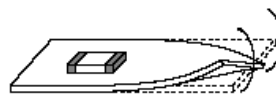
Sharp material such as a pair of tweezers or other material such as bristles of cleaning brush, shall not be touched to the winding portion to prevent the breaking of wire.

Mechanical shock should not be applied to the products mounted on the board to prevent the breaking of the core

**10.10 Handling of a substrate**

After mounting products on a substrate, do not apply any stress to the product caused by bending or twisting to the substrate when cropping the substrate, inserting and removing a connector from the substrate or tightening screw to the substrate.

Excessive mechanical stress may cause cracking in the product.

**Bending****Twisting****10.11 Storage and Handling Requirements****(1) Storage period**

Use the products within 12 months after delivered.

Solderability should be checked if this period is exceeded.

**(2) Storage conditions**

Products should be stored in the warehouse on the following conditions.

Temperature : -10 ~ 40°C

Humidity : 15 to 85% relative humidity No rapid change on temperature and humidity

The electrode of the products is coated with solder. Don't keep products in corrosive gases such as sulfur, chlorine gas or acid, or it may cause oxidization of electrode, resulting in poor solderability.

Products should not be stored on bulk packaging condition to prevent the chipping of the core and the breaking of winding wire caused by the collision between the products.

Products should be stored on the palette for the prevention of the influence from humidity, dust and so on.

Products should be stored in the warehouse without heat shock, vibration, direct sunlight and so on.

**(3) Handling Condition**

Care should be taken when transporting or handling product to avoid excessive vibration or mechanical shock.

**11. Note**

⚠(1) Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.

(2) You are requested not to use our product deviating from the agreed specifications.

(3) The contents of this reference specification are subject to change without advance notice. Please approve our product specifications or transact the approval sheet for product specifications before ordering.

## OUR CERTIFICATE

DiGi provide top-quality products and perfect service for customer worldwide through standardization, technological innovation and continuous improvement. DiGi through third-party certification, we stricly control the quality of products and services. Welcome your RFQ to

Email: [Info@DiGi-Electronics.com](mailto:Info@DiGi-Electronics.com)



Tel: +00 852-30501935

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